



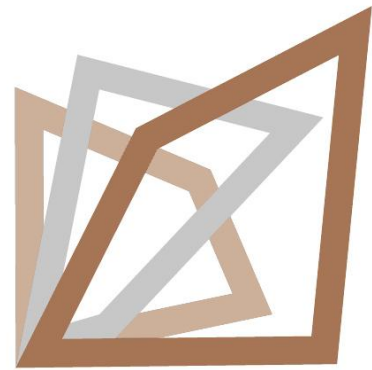
Copper Cu

Product format:

Tape electrical applications

Technical characteristics:

Tape or laminated copper for electrical applications



BRONMETAL

Copper Cu

Product format:

Tape electrical applications

Technical characteristics:

Tape or laminated copper strip for electrical applications



ALLOYS

Designation of material		Composition in % (mass fraction)									
		Element	Cu	Ag	Bi	O	P	Pb	Other elements (see note)		
Symbolic	Numerical								Total	Excluded	
Cu-ETP	CW004A	mín.	99.90 ^a	-	-	-	-	-	-	-	Ag, O
		máx.	-	-	0,0005	0.040 ^b	-	0,005	0,03		
Cu-FRHC	CW005A	mín.	99.90 ^a	-	-	-	-	-	-	-	Ag, O
		máx.	-	-	-	0.040 ^b	-	-	0,04		
Cu-OF	CW008A	mín.	99.95 ^a	-	-	-	-	-	-	-	Ag
		máx.	-	-	0,0005	- ^c	-	0,005	0,03		
CuAg0,10	CW013A	mín.	Resto	0,08	-	-	-	-	-	-	Ag, O
		máx.	-	0,12	0,0005	0.040 ^b	-	-	0,03		
CuAg0,10P	CW016A	mín.	Resto	0,08	-	-	0,001	-	-	-	Ag, P
		máx.	-	0,12	0,0005	- ^c	0,007	-	0,03		
CuAg0,10(OF)	CW019A	mín.	Resto	0,08	-	-	-	-	-	-	Ag, O
		máx.	-	0,12	0,0005	- ^c	-	-	0,0065		
Cu-PHC	CW020A	mín.	99.95 ^a	-	-	-	0,001	-	-	-	Ag, P
		máx.	-	-	0,0005	- ^c	0,006	0,005	-0,03		
Cu-HCP	CW021A	mín.	99.95 ^a	-	-	-	0,002	-	-	-	Ag, P
		máx.	-	-	0,0005	- ^c	0,007	0,005	0,03		

NOTE - Total other items (other than copper) is defined as the sum of Ag, As, Bi, Cd, Co, Cr, Fe, Mn, Ni, O, P, Pb, S, Sb, Se, Si, Sn, Te y Zn, with the exclusion of any item whose value is indicated individually.

^a To including silver, to a maximum of 0.015%.

^b The permissible oxygen content up to 0.060%, subject to agreement between customer and supplier..

^c The oxygen content should be such that the material meets the requirements of embrittlement by heating in hydrogen atmosphere of the standard in 1976.